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MOS FIELD EFFECT POWER TRANSISTOR 2SK1294

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK1294 is N-channel MOS Field Effect Transistor designed for solenoid, motor and lamp driver.

FEATURES

• Low On-state Resistance

$$\begin{split} &R_{DS(on)} \leq 27~m\Omega~(V_{GS}=10~V,~I_{D}=20~A) \\ &R_{DS(on)} \leq 50~m\Omega~(V_{GS}=4~V,~I_{D}=20~A) \end{split}$$

- Low Ciss Ciss = 3 250 pF TYP.
- Built-in G-S Gate Protection Diodes

QUALITY GRADE

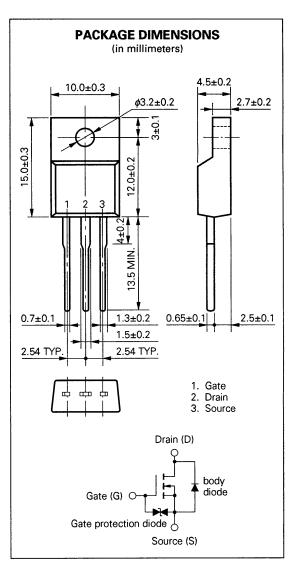
Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C)

| Drain to Source Voltage | Voss | 60 | ٧ |
|--------------------------------------|-----------------|-------------|----|
| Gate to Source Voltage | VGSS(AC) | ±20 | ٧ |
| Drain Current (DC) | ID(DC) | ±40 | Α |
| Drain Current (pulse) | D(pulse)* | ±160 | Α |
| Total Power Dissipation (Ta = 25 °C) | P _{T1} | 2.0 | W |
| Total Power Dissipation (Tc = 25 °C) | PT2 | 35 | W |
| Channel Temperature | Tch | 150 | °C |
| Storage Temperature | T_{stg} | -55 to +150 | °C |

^{*} PW \leq 10 μ s, Duty Cycle \leq 1 %

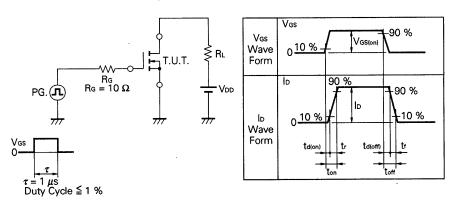


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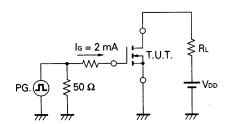
ELECTRICAL CHARACTERISTICS (Ta = 25 °C)

| CHARACTERISTIC | SYMBOL | MIN. | TYP. | MAX. | UNIT | TEST CONDITIONS |
|-------------------------------------|----------|------|-------|------|------|---|
| Drain to Source On-state Resistance | RDS(on) | | 22 | 27 | mΩ | Vgs = 10 V, lp = 15 A |
| Drain to Source On-state Resistance | RDS(on) | | 30 | 50 | mΩ | Vgs = 4.0 V, lp = 15 A |
| Gate to Source Cutoff Voltage | VGS(off) | 1.0 | | 2.5 | V | Vps = 10 V, lp = 1 mA |
| Forward Transfer Admittance | Yfs | 12 | | | s | Vos = 10 V, lo = 15 A |
| Drain Leakage Current | ID88 | | | 10 | μΑ | Vps = 60 V, Vgs = 0 |
| Gate to Source Leakage Current | lgss | | | ±10 | μΑ | Vgs = ±20 V, Vps = 0 |
| Input Capacitance | Ciss | | 3 250 | | pF | V _{DS} = 10 V V _{GS} = 0 f = 1 MHz |
| Output Capacitance | Coss | | 1 200 | | pF | |
| Reverse Transfer Capacitance | Cres | | 380 | | pF | |
| Turn-On Delay Time | td(on) | | 60 | | ns | $V_{GS(on)} = 10 \text{ V}$ $V_{DD} = 30 \text{ V}$ $I_{D} = 20 \text{ A, Rg} = 10 \Omega$ $R_{L} = 1.5 \Omega$ |
| Rise Time | tr | | 500 | | ns | |
| Turn-Off Delay Time | td(off) | | 250 | | ns | |
| Fall Time | tr | | 160 | | ns | |
| Total Gate Charge | Qc | | 85 | | nC | Vas = 10 V Ib = 40 A Vbb = 48 V |
| Gate to Source Charge | Qgs | | 10 | | nC | |
| Gate to Drain Charge | Qgp | | 35 | | nC | |
| Diode Forward Voltage | VsD | | 1.2 | | V | IsD = 40 A, Vgs = 0 |
| Reverse Recovery Time | trr | | 130 | | ns | I _F = 40 A, V _{GS} = 0 di/dt = 50 A/μs |
| Reverse Recovery Charge | Qrr | | 200 | | nC | |

Test Circuit 1: Switching Time

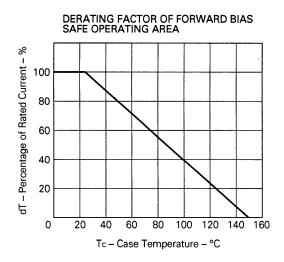


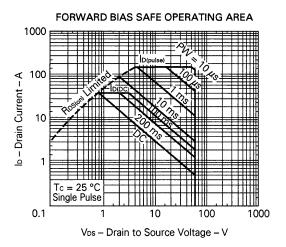
Test Circuit 2: Gate Charge

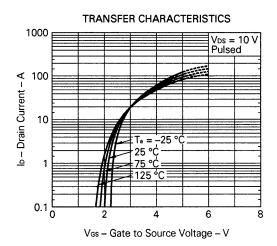


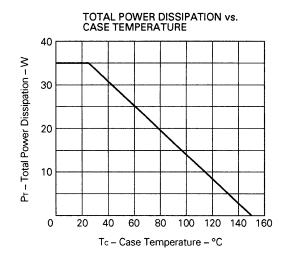
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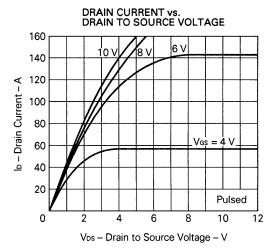
TYPICAL CHARACTERISTICS (Ta = 25 °C)

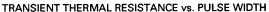


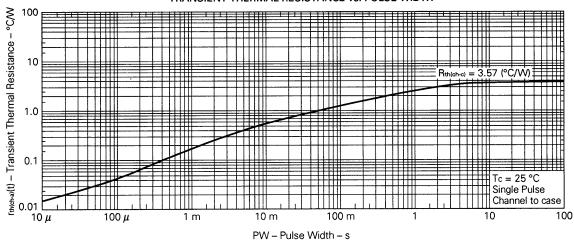




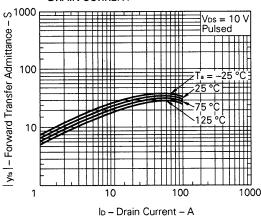




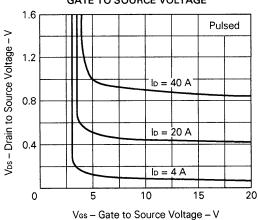




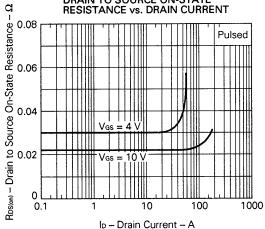
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



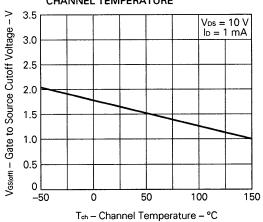
DRAIN TO SOURCE VOLTAGE vs. GATE TO SOURCE VOLTAGE

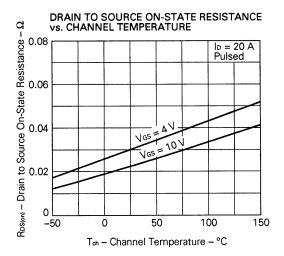


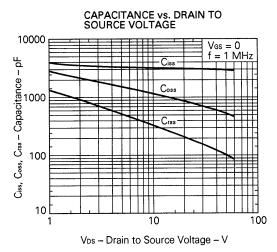
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

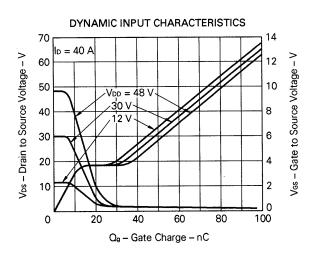


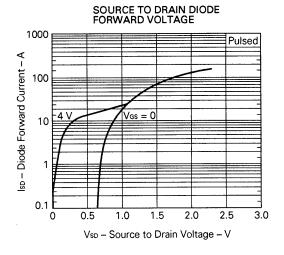
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

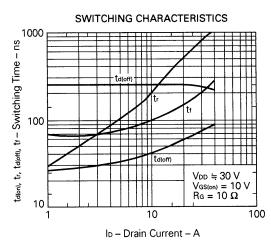


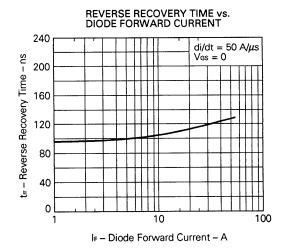












Reference

| Application note name | No. |
|--|----------|
| Safe operating area of Power MOS FET. | TEA-1034 |
| Application circuit using Power MOS FET. | TEA-1035 |
| Quality control of NEC semiconductors devices. | TEI-1202 |
| Quality control guide of semiconductors devices. | MEI-1202 |
| Assembly manual of semiconductors devices. | IEI-1207 |

NEC 2SK1294

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